

January 2008

# 74AC14, 74ACT14 Hex Inverter with Schmitt Trigger Input

### **Features**

- I<sub>CC</sub> reduced by 50%
- Outputs source/sink 24mA
- 74ACT14 has TTL-compatible inputs

### **General Description**

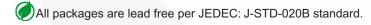
The 74AC14 and 74ACT14 contain six inverter gates each with a Schmitt trigger input. They are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals. In addition, they have a greater noise margin than conventional inverters.

The 74AC14 and 74ACT14 have hysteresis between the positive-going and negative-going input thresholds (typically 1.0V) which is determined internally by transistor ratios and is essentially insensitive to temperature and supply voltage variations.

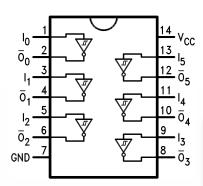
### **Ordering Information**

Order Number	Package Number	Package Description
74AC14SC	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74AC14SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74AC14MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74AC14PC	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
74ACT14SC	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74ACT14MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74ACT14PC	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.



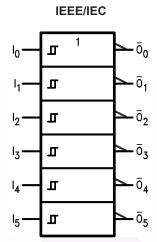
# **Connection Diagram**



# **Pin Description**

Pin Names	Description
In	Inputs
$\overline{O}_n$	Outputs

# **Logic Symbol**



## **Function Table**

Input	Output
Α	ō
L	Н
Н	L

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V <sub>CC</sub>	Supply Voltage	-0.5V to +7.0V
I <sub>IK</sub>	DC Input Diode Current	
	$V_{I} = -0.5V$	-20mA
	$V_{I} = V_{CC} + 0.5$	+20mA
V <sub>I</sub>	DC Input Voltage	-0.5V to V <sub>CC</sub> + 0.5V
I <sub>OK</sub>	DC Output Diode Current	
	$V_{O} = -0.5V$	–20mA
	$V_O = V_{CC} + 0.5V$	+20mA
Vo	DC Output Voltage	-0.5V to V <sub>CC</sub> + 0.5V
Io	DC Output Source or Sink Current	±50mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current per Output Pin	±50mA
T <sub>STG</sub>	Storage Temperature	−65°C to +150°C
T <sub>J</sub>	Junction Temperature	140°C

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V <sub>CC</sub>	Supply Voltage	
	AC	2.0V to 6.0V
	ACT	4.5V to 5.5V
V <sub>I</sub>	Input Voltage	0V to V <sub>CC</sub>
Vo	Output Voltage	0V to V <sub>CC</sub>
T <sub>A</sub>	Operating Temperature	-40°C to +85°C

### **DC Electrical Characteristics for AC**

		V <sub>CC</sub>		<b>T</b> <sub>A</sub> = ·	+25°C	T <sub>A</sub> = -40°C to +85°C	
Symbol	Parameter	(V)	Conditions	Тур	Guara	nteed Limits	Units
V <sub>OH</sub>	Minimum HIGH Level	3.0	I <sub>OUT</sub> = -50μA	2.99	2.9	2.9	V
	Output Voltage	4.5		4.49	4.4	4.4	
		5.5		5.49	5.4	5.4	
		3.0	I <sub>OH</sub> = 12mA		2.56	2.46	
		4.5	I <sub>OH</sub> = 24mA		3.86	3.76	
		5.5	$I_{OH} = 24 \text{mA}^{(1)}$		4.86	4.76	
V <sub>OL</sub>	Maximum LOW Level	3.0	$I_{OUT} = 50\mu A$	0.002	0.1	0.1	V
	Output Voltage	4.5		0.001	0.1	0.1	
		5.5		0.001	0.1	0.1	
		3.0	I <sub>OL</sub> = 12mA		0.36	0.44	
		4.5	I <sub>OL</sub> = 24mA		0.36	0.44	
		5.5	$I_{OL} = 24 \text{mA}^{(1)}$		0.36	0.44	
I <sub>IN</sub> <sup>(3)</sup>	Maximum Input Leakage Current	5.5	$V_I = V_{CC}$ , GND		±0.1	±1.0	μA
V <sub>t+</sub>	Maximum Positive	3.0	T <sub>A</sub> = Worst Case		2.2	2.2	V
	Threshold	4.5			3.2	3.2	
		5.5			3.9	3.9	
V <sub>t</sub> _	Minimum Negative	3.0	T <sub>A</sub> = Worst Case		0.5	0.5	V
	Threshold	4.5			0.9	0.9	
		5.5			1.1	1.1	
V <sub>H(MAX)</sub>	Maximum Hysteresis	3.0	T <sub>A</sub> = Worst Case		1.2	1.2	V
		4.5			1.4	1.4	
		5.5			1.6	1.6	
V <sub>H(MIN)</sub>	Minimum Hysteresis	3.0	T <sub>A</sub> = Worst Case		0.3	0.3	V
		4.5			0.4	0.4	
		5.5			0.5	0.5	
I <sub>OLD</sub>	Minimum Dynamic	5.5	V <sub>OLD</sub> = 1.65V Max.			75	mA
I <sub>OHD</sub>	Output Current <sup>(2)</sup>	5.5	V <sub>OHD</sub> = 3.85V Min.			<b>–</b> 75	mA
I <sub>CC</sub> <sup>(3)</sup>	Maximum Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND		2.0	20.0	μA

#### Notes:

- 1. All outputs loaded; thresholds on input associated with output under test.
- 2. Maximum test duration 2.0ms, one output loaded at a time.
- 3.  $I_{IN}$  and  $I_{CC}$  @ 3.0V are guaranteed to be less than or equal to the respective limit @ 5.5V  $V_{CC}$ .

# **DC Electrical Characteristics for ACT**

		$V_{CC}$ $T_A = +25^{\circ}C$		+25°C	T <sub>A</sub> = -40°C to +85°C		
Symbol	Parameter	(V)	Conditions	Тур.	G	Guaranteed Limits	Units
V <sub>IH</sub>	Minimum HIGH Level	4.5	$V_{OUT} = 0.1V$ or	1.5	2.0	2.0	V
	Input Voltage	5.5	V <sub>CC</sub> – 0.1V	1.5	2.0	2.0	1
V <sub>IL</sub>	Maximum LOW Level	4.5	$V_{OUT} = 0.1V$ or	1.5	0.8	0.8	V
	Input Voltage	5.5	V <sub>CC</sub> – 0.1V	1.5	0.8	0.8	
V <sub>OH</sub>	Minimum HIGH Level	4.5	$I_{OUT} = -50\mu A$	4.49	4.34	4.4	V
	Output Voltage	5.5		5.49	5.4	5.4	
		4.5	$V_{IN} = V_{IL} \text{ or } V_{IH},$ $I_{OH} = -24\text{mA}$		3.86	3.76	
		5.5	$V_{IN} = V_{IL} \text{ or } V_{IH},$ $I_{OH} = -24\text{mA}^{(4)}$		4.86	4.76	
V <sub>OL</sub>	Maximum LOW Level	4.5	$I_{OUT} = 50\mu A$	0.001	0.1	0.1	V
	Output Voltage	5.5		0.001	0.1	0.1	
		4.5	$V_{IN} = V_{IL} \text{ or } V_{IH},$ $I_{OL} = 24\text{mA}$		0.36	0.44	
		5.5	$V_{IN} = V_{IL} \text{ or } V_{IH},$ $I_{OL} = 24\text{mA}^{(4)}$		0.36	0.44	
I <sub>IN</sub>	Maximum Input Leakage Current	5.5	$V_I = V_{CC}$ , GND		±0.1	±1.0	μА
$V_{H(MAX)}$	Maximum Hysteresis	4.5	T <sub>A</sub> = Worst Case		1.4	1.4	V
		5.5			1.6	1.6	
V <sub>H(MIN)</sub>	Minimum Hysteresis	4.5	T <sub>A</sub> = Worst Case		0.4	0.4	V
		5.5			0.5	0.5	
V <sub>t+</sub>	Maximum Positive	4.5	T <sub>A</sub> = Worst Case		2.0	2.0	V
	Threshold	5.5			2.0	2.0	
V <sub>t-</sub>	Minimum Negative	4.5	T <sub>A</sub> = Worst Case		0.8	0.8	V
	Threshold	5.5			0.8	0.8	
I <sub>CCT</sub>	Maximum I <sub>CC</sub> /Input	5.5	$V_I = V_{CC} - 2.1V$	0.6		1.5	mA
I <sub>OLD</sub>	Minimum Dynamic	5.5	V <sub>OLD</sub> = 1.65V Max.			75	mA
I <sub>OHD</sub>	Output Current <sup>(5)</sup>	5.5	V <sub>OHD</sub> = 3.85V Min.			<b>–</b> 75	mA
I <sub>CC</sub>	Maximum Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND		2.0	20.0	μA

### Notes:

- 4. All outputs loaded; thresholds on input associated with output under test.
- 5. Maximum test duration 2.0ms, one output loaded at a time.

# **AC Electrical Characteristics for AC**

			T <sub>A</sub> C	_ = +25° L = 50p	C, F		to +85°C, 50pF	
Symbol	Parameter	$V_{CC}(V)^{(6)}$	Min.	Тур.	Max.	Min.	Max.	Units
t <sub>PLH</sub>	Propagation Delay	3.3	1.5	9.5	13.5	1.5	15.0	ns
		5.0	1.5	7.0	10.0	1.5	11.0	
t <sub>PHL</sub>	Propagation Delay	3.3	1.5	7.5	11.5	1.5	13.0	ns
		5.0	1.5	6.0	8.5	1.5	9.5	

#### Note:

6. Voltage range 3.3 is  $3.3V \pm 0.3V$ . Voltage range 5.0 is  $5.0V \pm 0.5V$ .

# **AC Electrical Characteristics for ACT**

				\ = +25° L = 50p		T <sub>A</sub> = -40°C C <sub>L</sub> =	to +85°C, 50pF	
Symbol	Parameter	$V_{CC}(V)^{(7)}$	Min.	Тур.	Max.	Min.	Max.	Units
t <sub>PLH</sub>	Propagation Delay	5.0	3.0	8.0	10.0	3.0	11.0	ns
t <sub>PHL</sub>	Propagation Delay	5.0	3.0	8.0	10.0	3.0	11.0	ns

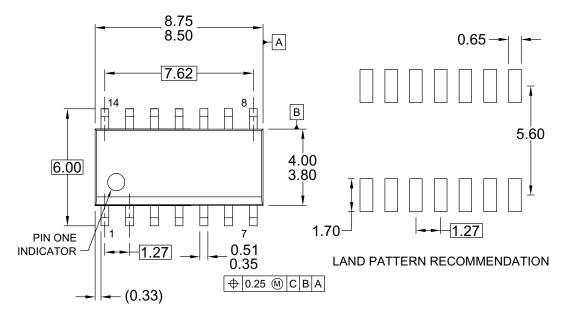
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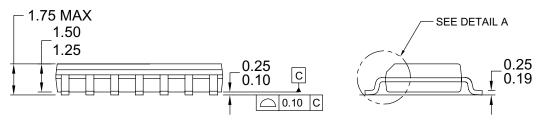
7. Voltage Range 5.0 is  $5.0V \pm 0.5V$ .

# Capacitance

Symbol	Parameter	Conditions	Тур	Units
C <sub>IN</sub>	Input Capacitance	V <sub>CC</sub> = OPEN	4.5	pF
C <sub>PD</sub>	Power Dissipation Capacitance	V <sub>CC</sub> = 5.0V		
	AC		25.0	pF
	ACT		80	

### **Physical Dimensions**





NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO JEDEC
  MS-012, VARIATION AB, ISSUE C,
  B) ALL DIMENSIONS ARE IN MILLIMETERS.
  C) DIMENSIONS DO NOT INCLUDE MOUD.
  - C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
  - D) LANDPATTERN STANDARD: SOIC127P600X145-14M
  - E) DRAWING CONFORMS TO ASME Y14.5M-1994
  - F) DRAWING FILE NAME: M14AREV13

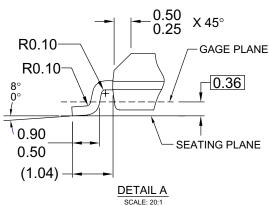


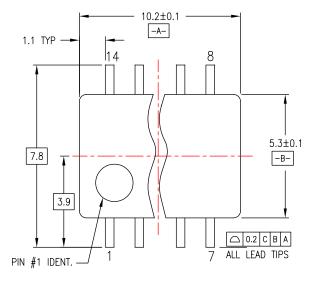
Figure 1. 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow

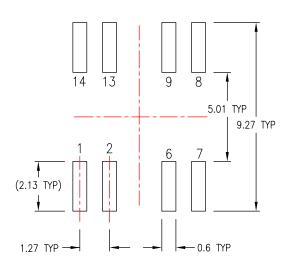
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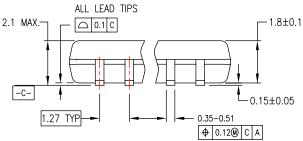
http://www.fairchildsemi.com/packaging/

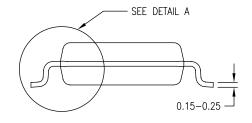
### Physical Dimensions (Continued)





LAND PATTERN RECOMMENDATION



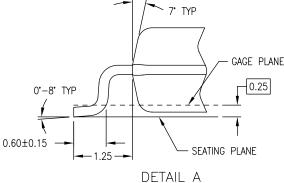


DIMENSIONS ARE IN MILLIMETERS

### NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
  B. DIMENSIONS ARE IN MILLIMETERS.
  C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD

FLASH, AND TIE BAR EXTRUSIONS.



M14DREVC

Figure 2. 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

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### Physical Dimensions (Continued) 5.0±0.1 -A-0.65 0.43 TYP 6.4 4.4±0.1 -B-1.65 3.2 □ 0.2 C B A PIN #1 IDENT. 6.10 0.45LAND PATTERN RECOMMENDATION SEE DETAIL A ALL LEAD TIPS 0.90+0.15 1.2 MAX □ 0.1 C 0.09-0.20 -C-0.10±0.05 0.65 0.19 - 0.30⊕ |0.13\\(\) |A |B\(\) |C\(\) 12.00°TOP & BOTTOM R0.09 min GAGE PLANE 0.25 0°-8° NOTES: 0.6±0.1 A. CONFORMS TO JEDEC REGISTRATION MO-153, SEATING PLANE R0.09min VARIATION AB, REF NOTE 6 1 00 **B. DIMENSIONS ARE IN MILLIMETERS DETAIL A**

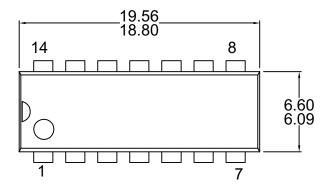
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1982
- E. LANDPATTERN STANDARD: SOP65P640X110-14M
- F. DRAWING FILE NAME: MTC14REV6

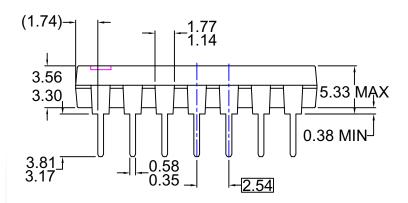
Figure 3. 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

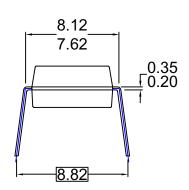
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### Physical Dimensions (Continued)







NOTES: UNLESS OTHERWISE SPECIFIED THIS PACKAGE CONFORMS TO

- A) JEDEC MS-001 VARIATION BA
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
  DIMENSIONS ARE EXCLUSIVE OF BURRS.
- C) MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D) DIMENSIONS AND TOLERANCES PER ASME Y14.5-1994
- E) DRAWING FILE NAME: MKT-N14AREV7

Figure 4. 14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

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Datasheet Identification	Product Status	Definition
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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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